

EIE 9008 SMT Stencil Cleaner

DESCRIPTION

EIE 9008 is a bi-polar fast drying odour free SMT stencil-cleaner formulated to remove solder paste residue from stencils, squeegees, printers, tools, PCBs, leaving no residue. An excellent all purpose cleaner and degreaser, it is design to be used for rosin-based, no-clean and water-soluble type of solder paste stencil cleaning. It is suitable for both semi-auto and automatic in-line wiper solder-paste stencil printing equipment assembly. Formula EIE 9008 is safe with most plastic and can be used as degreaser to remove rosin or resin residues, oils and grease etc. EIE 9008 is CFCs free.

ADVANTAGES VS IPA

- Dry faster, hence less drag-in to solder-paste, as too much drag-in will affect the rheology (viscosity) of the paste
- Less smearing deposition of paste
- Able to clean and remove non-polar residue like paste's residue effectively

PHYSICAL PROPERTIES

Appearance
Sp. Gravity @25°C
pH.
Flash Point (T.O.C.)
Auto-Ignition temperature
Odour

Clear Liquid 0.70 ± 0.01 Neutral (7.0) <16°C Flammable >260°C

slight ether

DISPOSAL

License waste disposal solvent contractors. Refer to local regulatory authority.

PACKAGING

25 litre carboy / 200litre drum